

BUL810

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

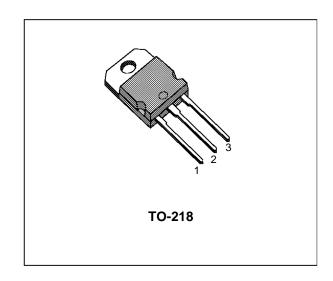
- SGS-THOMSON PREFERRED SALESTYPE
- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- LOW BASE-DRIVE REQUIREMENTS
- VERY HIGH SWITCHING SPEED
- FULLY CHARACTERISED AT 125°C

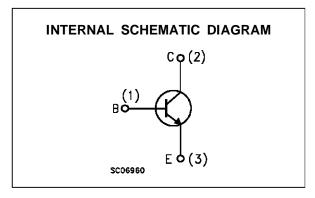
APPLICATIONS

- ELECTRONIC TRANSFORMER FOR HALOGEN LAMPS
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES



The BUL810 is manufactured using high voltage Multiepitaxial Mesa technology for cost-effective high performance. It uses a Hollow Emitter structure to enhance switching speeds. The BUL series is designed for use in lighting applications and low cost switch-mode power supplies.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vces	Collector-Emitter Voltage (V _{BE} = 0)	1000	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	450	V
V _{EBO}	Emitter-Base Voltage (I _C = 0)	9	V
Ic	Collector Current	15	Α
I _{CM}	Collector Peak Current (t _p < 5 ms)	22	Α
I _B	Base Current	5	Α
I _{BM}	Base Peak Current (t _p < 5 ms)	10	Α
P _{tot}	Total Dissipation at T _c = 25 °C	125	W
T _{stg}	Storage Temperature Range	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

December 1994 1/6

THERMAL DATA

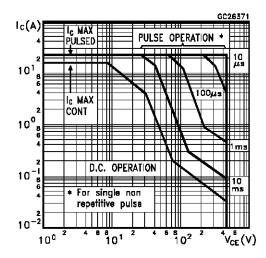
R _{thj-case}	Thermal Resistance June	ction-Case Max	1	°C/W	
$R_{thj-amb}$	Thermal Resistance June	ction-Ambient Max	62.5	°C/W	

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

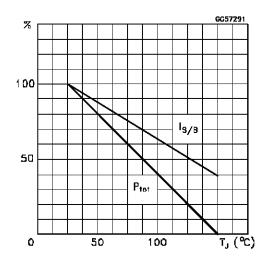
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Ices	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = 1000 V V _{CE} = 1000 V T _j = 125 °C			100 500	μA μA
I _{CEO}	Collector Cut-off Current (I _B = 0)	V _{CE} = 450 V			250	μА
V _{CEO(sus)}	Collector-Emitter Sustaining Voltage	I _C = 100 mA L = 25 mH	450			V
V_{EBO}	Emitter-Base Voltage (I _C = 0)	I _E = 10 mA	9			V
V _{CE(sat)*}	Collector-Emitter Saturation Voltage	I _C = 5 A I _B = 1 A I _C = 8 A I _B = 1.6 A I _C = 12 A I _B = 2.4 A			1 1.5 5	V V V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = 5 A I _B = 1 A I _C = 8 A I _B = 1.6 A			1.3 1.6	V V
h _{FE} *	DC Current Gain	I _C = 5 A V _{CE} = 5 V I _C = 10 mA V _{CE} = 5 V	10 10		40	
t _s t _f	INDUCTIVE LOAD Storage Time Fall Time	$\begin{split} I_{C} &= 8 \text{ A} & I_{B1} = 1.6 \text{ A} \\ V_{BE (off)} &= -5 \text{ V} & R_{BB} = 0.4 \Omega \\ V_{CL} &= 350 \text{ V} & L = 200 \mu\text{H} \end{split}$		1.5 55	2.3 110	μs ns
t _s t _f	INDUCTIVE LOAD Storage Time Fall Time	$\begin{array}{cccccccccccccccccccccccccccccccccccc$		1.9 80		μs ns

^{*} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5 %

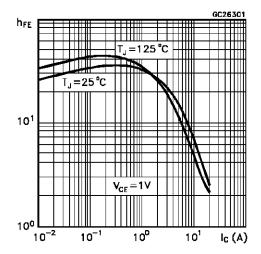
Safe Operating Areas



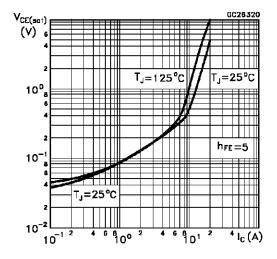
Derating Curves



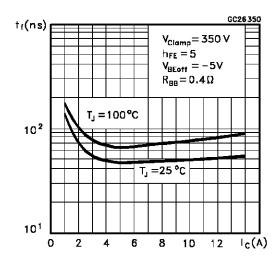
DC Current Gain



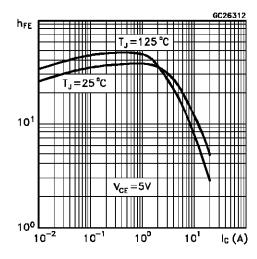
Collector Emitter Saturation Voltage



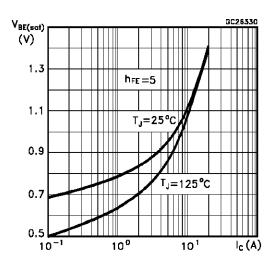
Inductive Fall Time



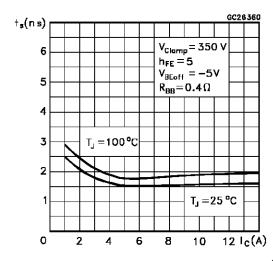
DC Current Gain



Base Emitter Saturation Voltage

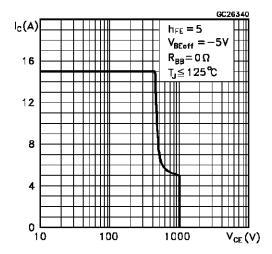


Inductive Storage Time

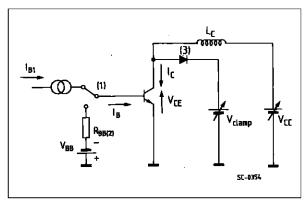




Reverse Biased SOA



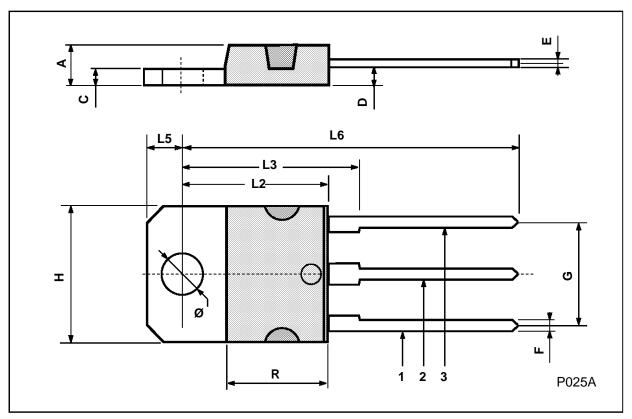
RBSOA and Inductive Load Switching Test Circuit



- (1) Fast electronic switch
- (2) Non-inductive Resistor
- (3) Fast recovery rectifier

TO-218 (SOT-93) MECHANICAL DATA

DIM.		mm		inch		
Diiii.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.7		4.9	0.185		0.193
С	1.17		1.37	0.046		0.054
D		2.5			0.098	
Е	0.5		0.78	0.019		0.030
F	1.1		1.3	0.043		0.051
G	10.8		11.1	0.425		0.437
Н	14.7		15.2	0.578		0.598
L2	_		16.2	-		0.637
L3		18			0.708	
L5	3.95		4.15	0.155		0.163
L6		31			1.220	
R	_		12.2	_		0.480
Ø	4		4.1	0.157		0.161



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